

Dear colleagues,

The 2nd China Heat Pump Conference (CHPC2024) will be held on August 27-30, 2024 in Shenzhen, China. The conference is sponsored jointly by China Association of Refrigeration (CAR) and the International Institute of Refrigeration (IIR), which covers essential information on the latest technologies, market applications, policies interpretation and standards information in heat pumps.

To provide more and high-quality submissions, we decide to postpone the abstract submission deadline to March 15, 2024. Meanwhile, we will organize special issue for the conference in *Advances in Applied Energy*, *Applied Energy*, *Energy* and *International Journal of Refrigeration*. High-quality submission to the conference will be recommended to these journals for publication.

We hope you will disseminate this information to your team and colleagues. Abstract submission and updated information about CHPC2024 could go to the conference website: <http://chpc2024.car.org.cn>

Look forward to seeing you in Shenzhen!

Sincerely yours,

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